

Serial Nr.: 10/829,115  
Art Unit: 2811

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**JUN 27 2005**

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

**Serial No.: 10/829,115 Examiner: Nitin Parekh**  
**Inventor: Shyh-Ming Chang, Yuan-Chang Huang, Wen-Chih Chen**  
**and Sheng-Shu Yang**  
**Filed: April 20, 2004 Art Unit: 2811**  
**Title: Bonding Structure With Compliant Bumps**

Certificate of Transmission under 37 CFR 1.8

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**Signature**

**Commissioner for Patents**  
**P.O. Box 1450**  
**Alexandria, VA 22313-1450**

Sir:

**AMENDMENT A**

In response to the Office Action mailed 03/18/2005, please amend the above-identified application as follows:

**Amendments to the Drawings begin on page 2 of this paper.**

**Amendments to the Specification** begin on page 3 of this paper.

**Amendments to the Abstract begin on page 8 of this paper.**

**Amendments to the Claims** are reflected in the listing of claims which begins on page 9 of this paper.

**Remarks begin on page 15 of this paper.**

**Petition for Extension of Time on page 17.**

**Amended Drawings following page 17 (8 sheets).**

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